

IEEE-NEMS 2024

The 19th IEEE International Conference on
Nano/Micro Engineered and Molecular Systems

May 2-5, 2024

Kyoto University of Advanced Science (KUAS)

KYOTO, Japan

Sponsors & Exhibition

Nano/Micro Engineered and Molecular Systems (NEMS) is a premier conference established in 2006 by the IEEE Nanotechnology Council to promote advanced research areas combining MEMS/NEMS (Micro/Nano Electro Mechanical Systems) and nano-biotechnology.

The areas of MEMS/NEMS and nano-biotechnology are considered to be fundamental technologies for engineering and science in the 21st century. The conference has been contributing to the development and nurturing of those areas by presenting and discussing research results integrating MEMS/NEMS and nano-biotechnology, creating a community among researchers, and educating and training students and young researchers who will be responsible for the next generation.

Japan, a world leader in MEMS/NEMS and nano-biotechnology, has played a leading role in Southeast Asia, hosting the conference in Kyoto in 2012, Sendai and Matsushima in 2016, and planning to hold the conference in Kyoto again in 2024. However, due to COVID-19, the meeting was postponed to 2024.

The 19th IEEE-NEMS in Kyoto with a lower registration fee encourages participation of young researchers from Asian countries and contributes to the development of young researchers.

We hope that you will support the purpose of the conference and joins us as sponsors.

General Chair
Ryuji Yokokawa, Kyoto University
General co-Chair
Osamu Tabata, Kyoto University of Advanced Science (KUAS)

PRIOR IEEE-NEMS Conferences

Jeju (Korea, 2023)
Taoyuan (Taiwan, 2022, Hybrid)
Xiamen (China, 2021, Hybrid)
Virtual (2020)
Bangkok (Thailand, 2019)
Singapore (2018)
Los Angeles (USA, 2017)
Matsushima Bay and Sendai (Japan, 2016)
Xi'an (China, 2015)
Hawaii (USA, 2014)
Suzhou (China, 2013)
Kyoto (Japan, 2012)
Kaohsiung (Taiwan, 2011)
Xiamen (China, 2010)
Shenzhen (China, 2009)
Hainan Island (China, 2008)
Bangkok (Thailand, 2007)
Zhuhai (China, 2006)

Conference Scope

- Micro/Nano Electro-Mechanical Systems (M/NEMS)
- Micro/Nano/Molecular Fabrication
- Functional Nanomaterials and Devices
- Nanophotonics and Nanoscale Imaging
- Nanoscale Robotics, Assembly, and Automation
- Micro/Nano/Molecular Sensors, Actuators, and Systems
- Micro/Nano Fluidics and Devices
- Micro/Nano Mechanics
- Nanobiology/Nanomedicine/Microphysiological Systems (MPS)



Conference Overview

- Conference Name: The 19th IEEE International Conference on Nano/Micro Engineered and Molecular Systems (IEEE-NEMS) 2024
- Co-Sponsored by IEEE Nanotechnology Council & Kyoto University of Advanced Science (KUAS)
- Conference Date: Thursday, May 2 – Sunday, May 5, 2024
- Exhibit Date: Friday, May 3 – Sunday, May 5, 2024
- Venue: Kyoto University of Advanced Science (KUAS) [Access](#)
18 Gotanda-cho, Yamanouchi, Ukyo-ku, Kyoto, Japan, 615-8577
- Conference format (Estimate):
 - Oral presentation & Poster Presentation
 - Expected presentation: Oral 160, Poster 90-140
 - Plenary Speeches/Keynote Speeches: 20
 - Invited Speeches: 80
 - Exhibition: 10-20
- Number of Participants (Estimate): 400
- Proceedings: Online proceedings

Important Dates:

- Two-Page Abstract Deadline: Monday, December 18, 2023
 - Notification of Acceptance: Monday, January 29, 2024
 - Late News Submission Deadline: Friday, February 9, 2024
 - Full-Paper Submission Deadline: Monday, February 26, 2024
- (Required to publish papers in Xplore and to be nominated for awards.)
- Early Bird Registration starts: Monday, January 29, 2024

Schedule for Exhibitors & Sponsors

- Application deadline: Wednesday, February 28, 2024
- Exhibitor Manual: available by end March, 2024
- Exhibit move-in: Thursday, May 2, 2024
- Exhibit move-out: Sunday, May 5 PM, 2024

Organizing Committee

General Chair	Ryuji Yokokawa, Kyoto University
General co-Chair	Osamu Tabata, Kyoto University of Advanced Science
Program Chair	Hiroyuki Kudo, Meiji University
Program co-Chair	Masaya Toda, Tohoku University
Publication Chair	Koji Sugano, Kobe University
Invited Session Chair	Yoshikazu Hirai, Kyoto University
Invited Session co-Chair	Hiroaki Onoe, Keio University
Local Organizing Chair	Koichi Nakamura, Kyoto University of Advanced Science
Local Organizing Co-Chair	Masayuki Nishi, Kyoto University of Advanced Science
Promotion Co-Chair	Akio Higo, The University of Tokyo
Promotion Co-Chair	Yoshihiko Isobe, MIRISE Technologies
Conference Secretariat	Yasuto Tsuruta, Kyoto University of Advanced Science



Kyoto University of Advanced Science (KUAS)



Sponsorship Packages

IEEE NEMS 2024 provides a variety of options for sponsor packages. The benefits of each package are summarized below.

	Platinum	Gold	Silver	Bronze
Complimentary registration	4	2	1	1
Logo on conference website/materials	✓	✓	✓	✓
1 page Ad included in the conference program	✓	✓	✓	✓
Logo on screen saver in session rooms	✓	✓	✓	✓
Logo on vertical banner in the conference venue	✓	✓	✓	✓
Exhibit Booth (Refer to the next page for exhibit booth information)	✓	✓	✓	
Participants list (name, affiliation, email) only participants who agree to share the information with sponsors	✓	✓		
1-min PR movie prior to one plenary speech	✓			
	¥800,000	¥500,000	¥300,000	¥200,000

Other Sponsorship Opportunities

Conference Bag with logo on bag <i>* 2 Opportunities Available</i>	✓	¥300,000
Lanyard Sponsor <i>* 1 Opportunities Available (exclusive sponsorship)</i>	✓	¥300,000
Coffee Break Sponsor <i>* 5 Opportunities Available</i>	✓	¥200,000

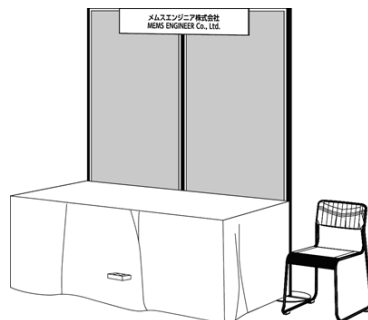
* All rates are shown exclusive of tax.

Exhibitor Packages

The benefits of the exhibitor package are summarized below.

	Academia	Regular
Complimentary registration	1	1
Exhibit space (1.8m wide, 0.9m depth, 2.1m height) including:		
- Cloth covered 1 table (1.8m wide, 0.9m depth, 2.1m height) with 1 chair	✓	✓
- Back panels (0.9m wide, 2.1m height) 2 panels connected - (Space for display: 1.8m wide x 1.2m height) - Company name board at the top of the back panel		
Exhibitor tabletop staff badges <i>* Badges grant access to exhibit hall, lunches and breaks</i>	✓	✓
Listed as exhibitor on website and printed materials	✓	✓
Identified as an exhibitor on signs during the Symposium	✓	✓
<i>* All rates are shown exclusive of tax.</i>	¥120,000	¥200,000

- » Exhibits may be set up 15:00-17:00 on May 2.
Must be set up prior to the beginning of the welcome reception which starts at 19:00, May 2.
- » Exhibits tear-down will occur May 5 right after the sessions are over.



Information Contact

IEEE NEMS 2024 Secretariat

✉ nems_2024@semiconportal.com